

SPECIFICATION

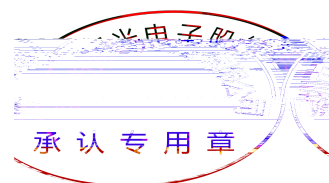
产品规格书

REFOND P/N 产品型号

RF-YUS150TS-AE

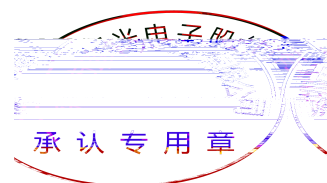
R&D 研发

Mass Product 量产供货



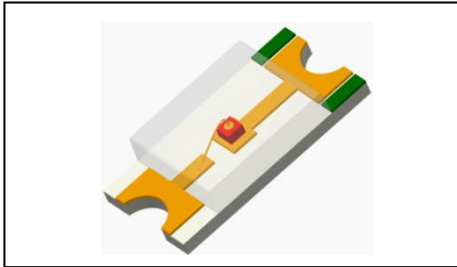
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1. Description 产品介绍

1.1 General Description 产品描述



The Colour LED which was fabricated using a yellow chip, Package Dimension : 3.2mmX1.6mmX0.7mm.

该产品为色光 LED，是由黄光芯片封装形成，产品尺寸：3.2mmX1.6mmX0.7mm。

1.2 Features 产品特征

Extremely wide viewing angle. 发光角度大

Suitable for all SMT assembly and solder process. 适用于所有的SMT组装和焊接工艺

Moisture sensitivity level: Level 3. 防潮等级 Level3

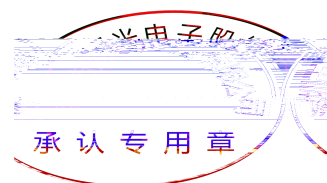
RoHS compliant. 满足RoHS要求

1.3 Application 产品应用

Optical indicator. 光学指示

Switch and symbol, display. 开关和标志，显示器等

General use. 其他应用



1.4 Package Dimension 封装尺寸

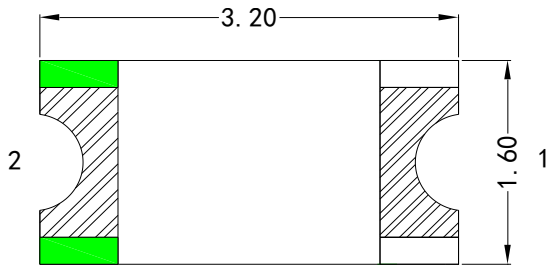


Fig.1-1 Top view 正面视图



Fig.1-2 Bottom view 背面视图

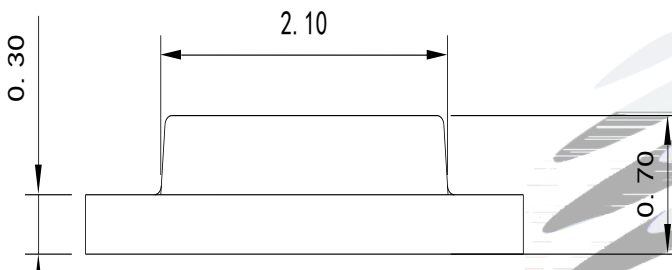


Fig.1-3 Side view 侧面视图

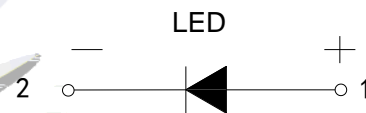
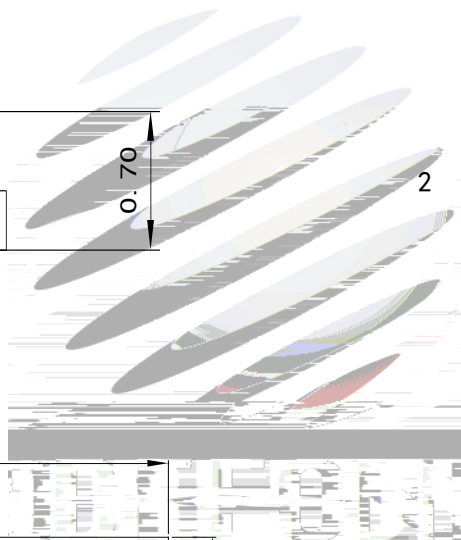


Fig.1-4 Polarity 极性

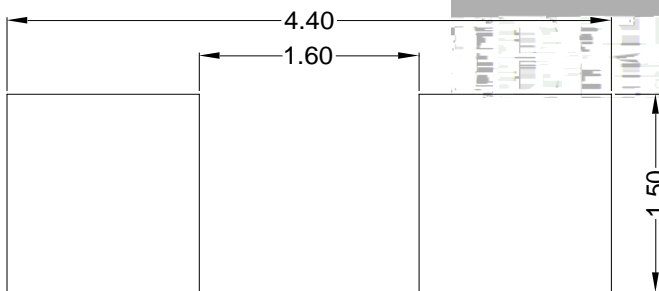
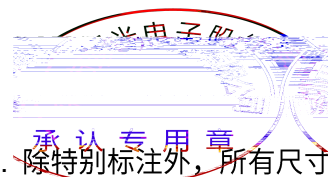


Fig.1-5 Soldering patterns 推荐焊盘

Notes 备注

1. All dimensions units are millimeters. 所有尺寸标注单位为毫米
2. All dimensions tolerances are $\pm 0.2\text{mm}$ unless otherwise noted. 除特别标注外, 所有尺寸公差为 ± 0.2 毫米

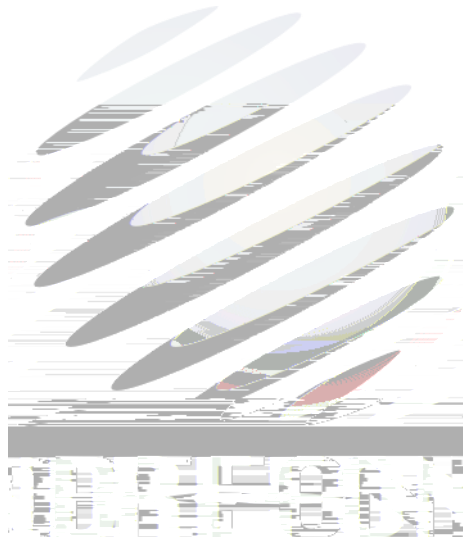


1.5 Product Parameters 产品参数

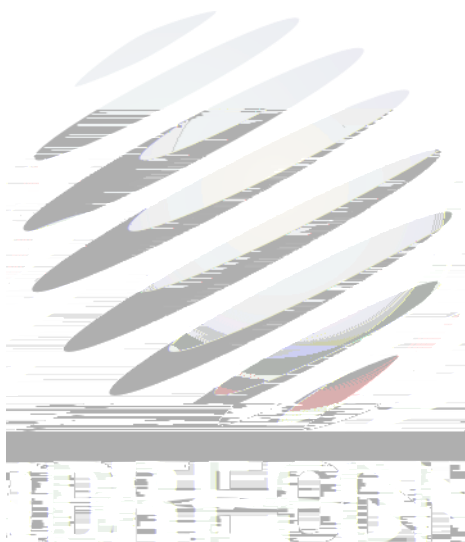
Table 1-1 Electrical / Optical Characteristics at Ts=25°C 电性与光学特性

Item 项目	Test Condition 测试条件	Symbol 符号	Value			Unit 单位
			Min. (最小值)	Typ. (典型值)	Max. (最大值)	

Spectral Half Bandwidth.f_i



Notes 备注: V_R=5V For test conditions. V_R=5V 为测试条件



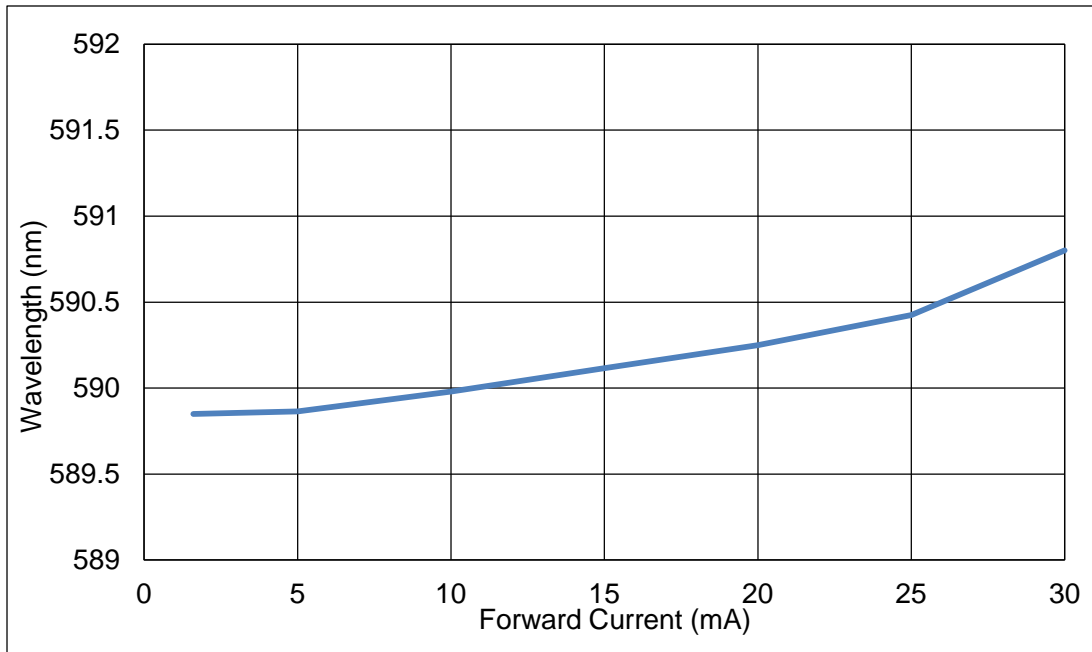


Fig 1-10 Forward Current Vs Dominate Wavelength (Ta=25°C) 正向电流与主波长关系曲线

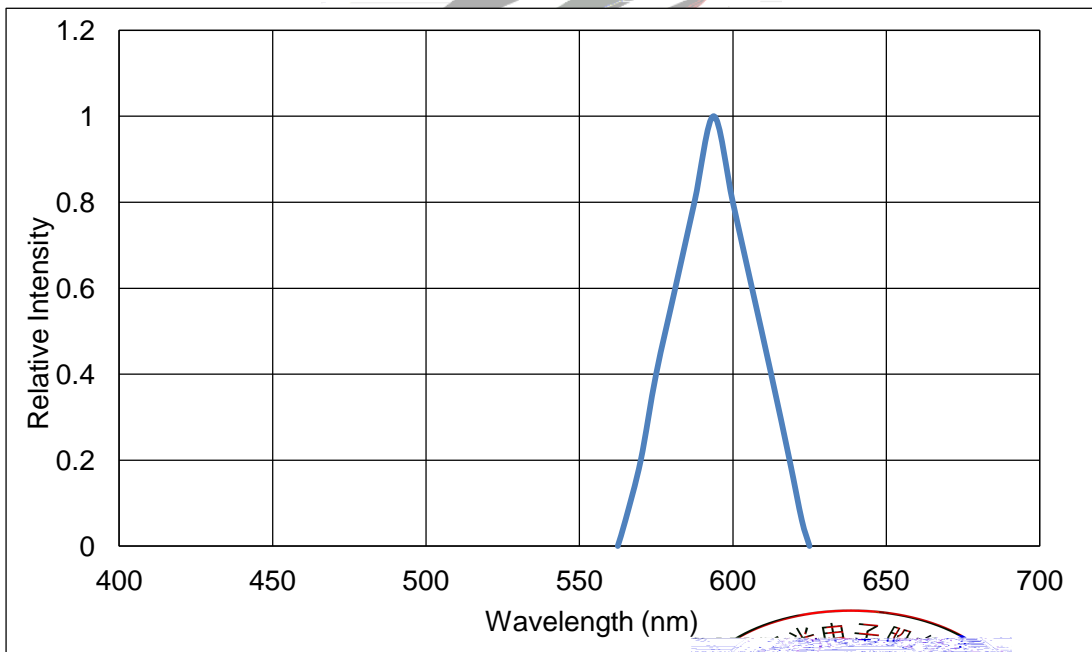


Fig 1-11 Relative Intensity Vs Wavelength (Ta=25°C) 相对光强与波长关系曲线

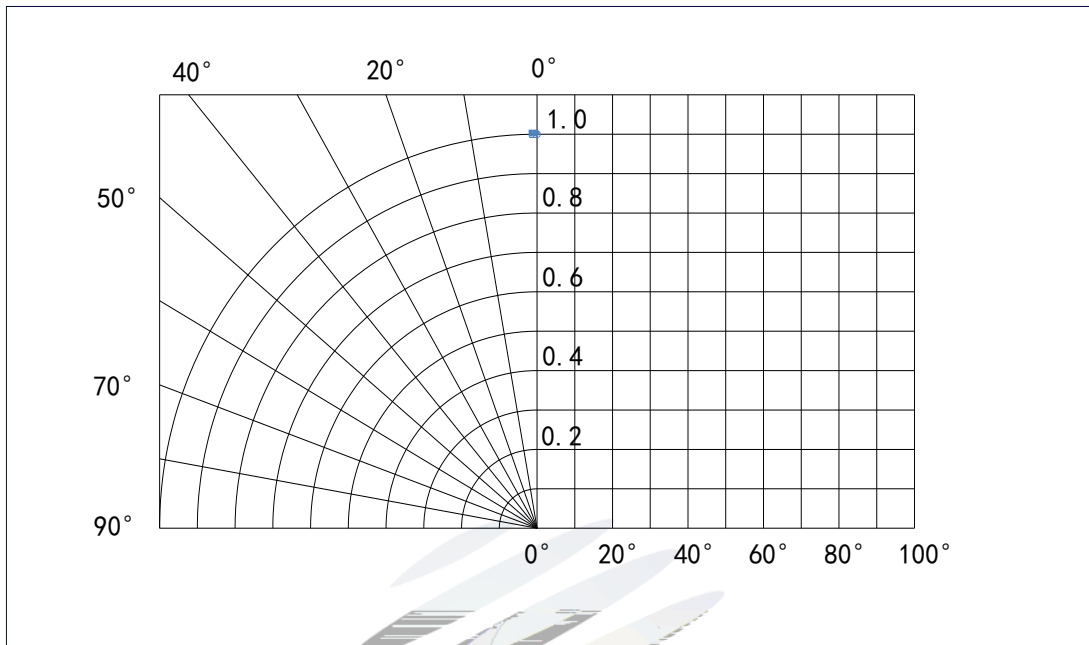
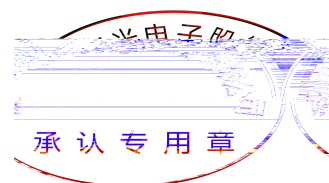
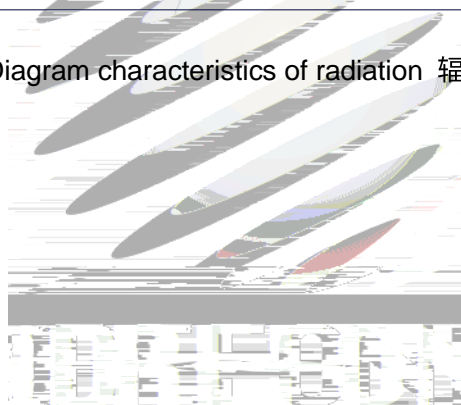


Fig 1-12 Diagram characteristics of radiation 辐射特性曲线



2. Packaging 产品包装

2.1 Packaging Specification 包装规格

Package:4000pcs/reel.包装每卷 4000pcs。

2.1.1 Carrier Tape Dimension 载带尺寸

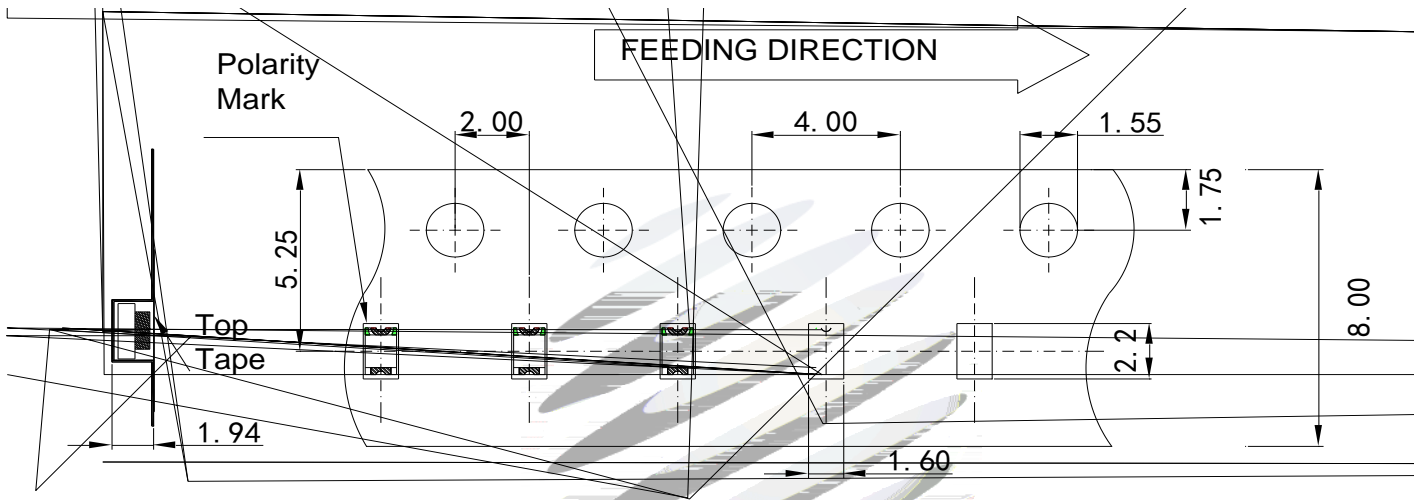


Fig.2-1 Carrier Tape Dimension 载带尺寸

2.1.2 Reel Dimension 卷盘尺寸

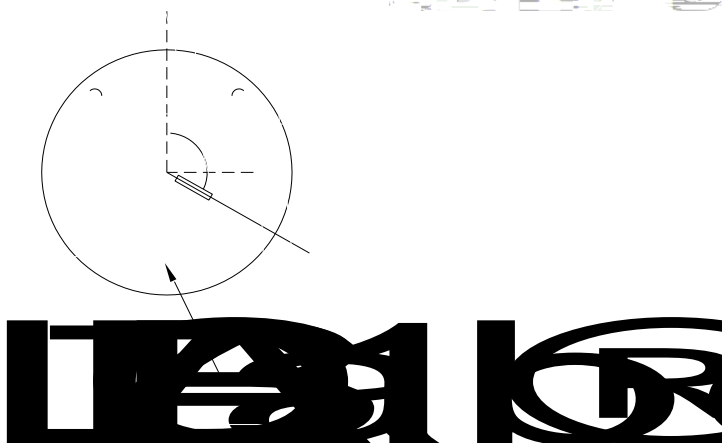


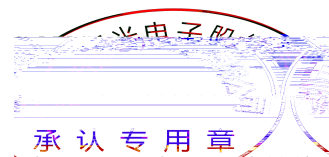
Fig.2-2 Reel Dimension 卷盘尺寸

Table 2-1 Dimension 尺寸

A	8.0±0.1mm
B	178±1mm
C	60±1mm
D	13.0±0.5mm

Notes 备注

The tolerances unless mentioned ± 0.1 mm. Unit : mm 注：未注公差为 ± 0.1 毫米，尺寸单位：毫米。



2.1.3 Label Form Specification 标签规格

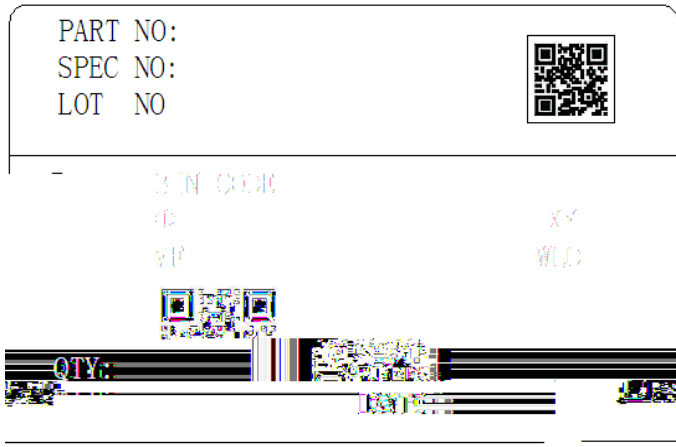


Fig. 2-3 Label Form Specification 标签规格

Table 2-2 Parameter 参数

PART NO.	Part Number 品名
SPEC NO.	Spec Number 规格
LOT NO.	Lot Number 批次号
BIN CODE	Bin Code 参数代码
	Luminous flux 光通量
XY	Chromaticity Bin 色区
V _F	Forward Voltage 正向电压
WLD	Wavelength 波长代码
QTY	Packing Quantity 数量
DATE	Made Date 生产日期

2.2 Moisture Resistant Packing 防潮包装

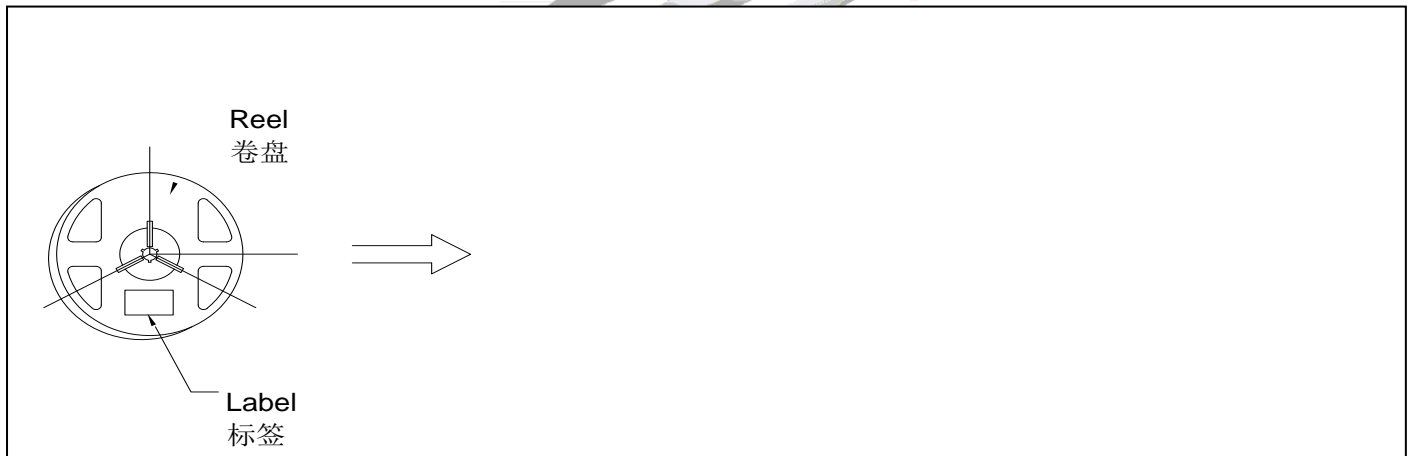
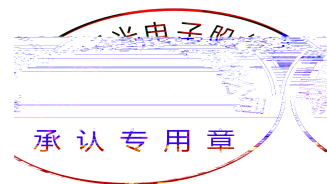


Fig.2-4 Moisture Resistant Packing 防潮包装





2.5 Criteria For Judging Damage 失效判定标准

Table 2-4 Criteria For Judging Damage 失效判定标准

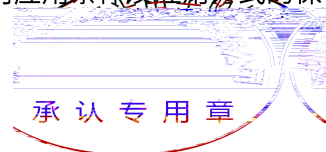
Test Items 项目	Symbol 符号	Test Condition 测试条件	Criteria For Judgement 判定标准	
			Min. 最小	Max. 最大
Forward Voltage 正向电压	V_F	$I_F=20mA$	-	U.S.L*)x1.1
Reverse Current 漏电流	I_R	$V_R= 5V$	-	U.S.L*)x2.0
Luminous Flux 光通量		$I_F=20mA$	L.S.L*)x0.7	-

Notes 备注:

1.U.S.L: Upper standard level 规格上限 L.S.L: Lower standard level 规格下限

2.The above reliability tests is based on the verification of a single/strip LED of Refond's existing experimental platform,the reliability experiment was taken under good heat dissipation conditions. When customers applies the LED to the series and parallel circuit,should take consideration of all the factors such as the current, voltage distribution, heat dissipation and others. 以上可靠性测试是基于瑞丰现有实验平台单颗/条 LED 在良好散热条件验证下的结果。客户端将 LED 应用于串、并联线路时,需自行评估电流、电压分配、散热等问题。

3.The technical information shown in the data sheets is limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license. 以上技术数据仅为产品的典型值,只作为参考,不作为任何应用条件及应用方式的保证。



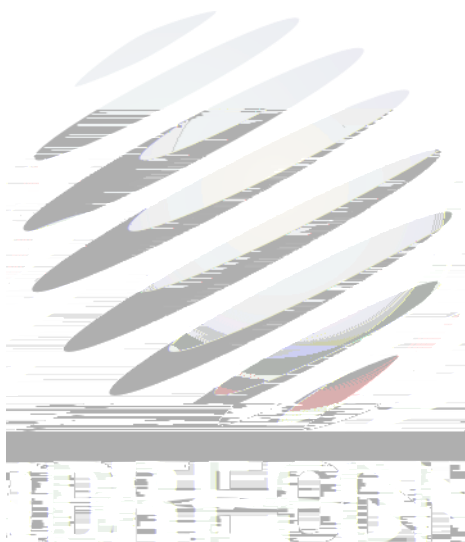
3. SMT Reflow Soldering Instructions SMT

3.1 SMT Reflow Soldering Instructions SMT 回流焊说明

Fig.3-1 SMT Reflow Soldering Instructions SMT 回流焊说明

Table 3-1 Parameter 参数

Average temperature rise speed平均升温速度 (T _{max} 至 T _P)	最高3 °C/秒 Max 3 °C/ s
Preheating: minimum temperature预热：最低温度 (T _{min})	150 °C
Preheating: Max temperature预热：最高温度 (T _{max})	200 °C
Preheating: Time预热：时间 (T _{min} 至 T _{max})	60 - 120秒



4. Handling Precautions 产品使用注意事项

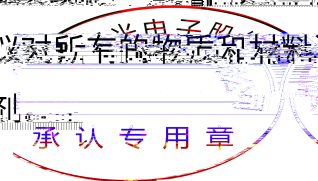
4.1 Handling Precautions 产品使用注意事项

(1) LED operating environment and sulfur element composition cannot be over 100PPM in the LED mating usage material. This is provided for informational purposes only and is not a warranty or endorsement. LED 工作环境及与 LED 适配的材料中硫元素及化合物成份不可超过 100PPM. 这只是一个建议，不作任何品质担保。

(2) In order to prevent external material from getting into the inside of LED, which may cause the malfunction of LED, the single content of Bromine element is required to be less than 900PPM, the single content of Chlorine element is required to be less than 900PPM, the total content of Bromine element and Chlorine element in the external materials of the application products is required to be less than 1500PPM. This is provided for informational purposes only and is not a warranty or endorsement. 为了防止外界物质进入 LED 内部以造成 LED 的损伤，所处环境及所用套件等等，单一的溴元素含量要求小于 900PPM，单一氯元素含量要求小于 900PPM，溴元素与氯元素总含量必须小于 1500PPM. 这只是一个建议，不作任何品质担保。

(3) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues. Refond advises against the use of any chemicals or materials that have been found or are suspected to have an adverse affect on device performance or reliability. To verify compatibility, Refond recommends that all chemicals and materials be tested in the specific application and environment for which they are intended to be used. Attaching LEDs, do not use adhesives that outgas organic vapor.

LED 内部，在通电产生光子及热的条件下，会导致 LED 变色，进而造成严重光衰，提前了解套件材料能够避免产生这些问题。瑞丰反对使用任何对 LED 器件的性能或者可靠性有害的物质或材料，不管这些材料是已经证实了的，还是仅仅怀疑有害。针对特定的用途和使用环境，瑞丰建议对所有物质和材料进行相容性的测试。在贴装 LED 时候，不要使用能产生有机挥发性气体的粘结剂。



(4) In designing a circuit, the current through each LED can not exceed the absolute maximum rating specified for each LED. In the meanwhile, resistors for protection should be applied, otherwise slight voltage shift will cause big current change, burn out may happen. The driving circuit must be designed to allow forward voltage only when it is ON or OFF. If the reverse voltage is applied to LED, migration can be generated resulting in LED damage. 设计电路时，通过 LED 的电流不能超过规定的最大值。同时，还需要使用保护电阻，否则，微小的电压变化将会引起较大电流变化，可能导致产品损毁。电路设计必须保证只有在开启或者关闭的时候出现正向电压的变化，不要施加反压，否则会损坏 LED。

(5) Thermal Design is paramount importance because heat generation may result in the Characteristics decline, such as brightness decreased, Color change and so on. Please consider the heat generation of the LEDs when making the system design. LED 容易因为自身的发热和环境温度的改变而改变，温度升高会降低 LED 发光效率，影响发光颜色，所以在设计时应充分考虑散热问题。

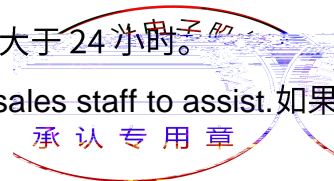
(6) Storage

Table 4-1 Storage 储存

Conditions 种类		Temperature 温度	Humidity 湿度	Time 时间
Storage 储存	Before Opening Aluminum Bag 拆包前	≤30°C	≤75%	Within 1 Year From Date 一年内
	After Opening Aluminum Bag 拆包后	≤30°C	≤60%	168hours 168小时
Baking 烘烤		60±5°C	-	≥24hours 大于24小时

(7) If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time , baking treatment should be performed after unpacking and based on the following condition (60±5) °C for above 24 hours. 如果干燥剂或包装失效，或者产品不符合以上有效储存条件，需拆包后进行烘烤。烘烤条件：60±5°C，大于24小时。

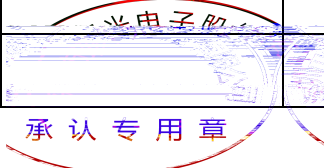
If the package is flatulence or damaged, please notify the sales staff to assist. 如果包装胀气或者破损，请通知销售人员协助处理。

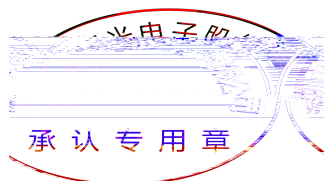




Version History/修订历史

Date日期	Revisor修订者	Version版本	Verifier审核	Remarks备注
2019.06.22	贾彬浩	E2	宋明	新版本制定





Declare 申明

This specification is written both in English and in Chinese and the latter is formal.

产品规格书以中英文方式书写，若有冲突以中文版本为准。